## Product Lineup 2024



# Leading Manufacturer of Clean Robot



Product Lineup

# SCR3160CSN-300-CM

## 3-Axis Cylindrical Coordinate Type Single-Arm Clean Robot

## Clean Robot SCR3000CSN Series

Featuring a step-out-less closed-loop control system, built-in batteryless absolute encoders and stepping motors, this series ensures high convenience, safety and stability as well as various ways of transferring. Suitable for various types of wafers up to 300 mm.



## Characteristics

- Step-out-less closed-loop control system under rapid load change or acceleration
- + Equipped with batteryless multi-rotation absolute sensors.
- + Path planning handling suitable for parallel layout is optional.
- Payload capacity: 3 kg or less (calculated on the arm 3rd joint)
- Compatible with the former SHR model and current SCR3000CS series, this SCR3000CSN series ensures easier replacement.

## Specifications

Carrying object	Wafers up to 300 mm			
	Arm	Rotation angle	Vertical stroke	
Operating range* (3rd joint center)	340 mm	340 degrees	300 mm	
Speed (Avg)*	610 mm/sec 340 degree/sec 250 m		250 mm/sec	
Speed (Max)*	1220 mm/sec	500 degree/sec	320 mm/sec	
Resolution*	10,0 µm or less	.0 μm or less 0.0015 degrees		
Handling level*	536 mm (Base mounting level to the end-effector level)			
Repeatability	Within +/- 0.1 mm			
Cleanliness	ISO Class 2 (when exhausted from the driving area)			
Utility*	Power: 24 V DC +/-	- 10%, 10 A; Vacuum	: -53 kPa or more	

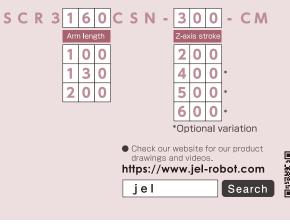
\*Specifications of SCR3160CSN-300-CM with a JEL standard vacuum type end-effector. Provide positive pressure depending on the wafer holding method such as edge grip or Bernoulli.

Robot' s main body weight: Approximately 22 kg

 Dimensions of C4000B controller: 297 (W) x 180 (D) x 120 (H), Weight: Approximately 5 kg Note: A CE/KCs compliant controller has different dimensions and weight.

## SCR3000 series

A wide range of variations to meet system layouts



# STCR4160SN-300-CM

## 4-Axis Cylindrical Coordinate Type Twin-Arm Clean Robot

## Clean Robot STCR4000SN Series

Featuring a step-out-less closed-loop control system, built-in batteryless absolute encoders and stepping motors, this series ensures high convenience, safety and stability as well as various ways of transferring. Suitable for various types of wafers up to 300 mm.

Option

Thin Wafe











## Characteristics

- Twin-arm reduces tact time to replace wafers.
- Step-out-less closed-loop control system under rapid load change or acceleration
- Equipped with battervless multi-rotation absolute sensors.
- + Path planning handling suitable for parallel layout is optional.
- Payload capacity: 3 kg or less (calculated on the arm 3rd joint)
- Compatible with the former STHR model and current STCR4000S series. this STCR4000SN series ensures easier replacement.

## **Specifications**

Carrying object	Wafers up to 300 mm			
	Arm	Rotation angle	Vertical stroke	
Operating range* (3rd joint center)	315 mm	340 degrees	300 mm	
Speed (Avg)*	570 mm/sec	220 degree/sec	200 mm/sec	
Speed (Max)*	1140 mm/sec	270 degree/sec	250 mm/sec	
Resolution*	12.6 µm or less	0.0045 degrees	6.25 μm	
Handling level*	620 mm (Base mounting level to the end-effector level)			
Repeatability	Within +/- 0.1 mm			
Cleanliness	ISO Class 2 (when exhausted from the driving area)			
Utility*	Power: 24 V DC +/-	- 10%, 10 A; Vacuum	: -53 kPa or more	

\*Specifications of STCR4160SN-300-CM with JEL standard vacuum type twin end-effectors. Provide positive pressure depending on the wafer holding method such as edge grip or Bernoulli.

Robot' s main body weight: Approximately 30 kg

 Dimensions of C4000B controller: 297 (W) x 180 (D) x 120 (H), Weight: Approximately 5 kg Note: A CE/KCs compliant controller has different dimensions and weight.

## STCR4000 series

• A wide range of variations to meet system layouts





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Controller: C4000B

Control method: RS232C and parallel photo I/O

# SCR3160CS-300-PM

## 3-Axis Cylindrical Coordinate Type Single-Arm Clean Robot

## **Clean Robot SCR3000CS Series**

Featuring an open-loop control system and stepping motors, this series ensures high safety and stability. This JEL's long-term standard robot allows users to customize easily. Suitable for various types of wafers up to 300 mm.



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## Characteristics

Specifications

- $\blacklozenge$  Base or flange mounting type is selectable according to system layouts.
- Optimal end-effector is selectable according to the carrying object and line layout.
- Payload capacity: 3 kg or less (calculated on the arm 3rd joint)
- Compatible with the former SHR model and current SCR3000CSN series, this SCR3000CS series ensures easier replacement.

Carrying object	Wafers up to 300 mm			
	Arm Rotation angle Vertical stroke			
Operating range* (3rd joint center)	340 mm 340 degrees		300 mm	
Speed (Avg)*	610 mm/sec 340 degree/sec 250 mm/sec			
Speed (Max)*	1220 mm/sec 500 degree/s		320 mm/sec	
Resolution*	12.6 μm or less 0.0045 degrees 6.2		6.25 μm	
Handling level*	536 mm (Base mounting level to the end-effector level)			
Repeatability	Within +/- 0.1 mm			
Cleanliness	ISO Class 2 (when exhausted from the driving area)			
Utility*	Power: 24 V DC +/-	- 10%, 15 A; Vacuum	n: -53 kPa or more	

\*Specifications of SCR3160CS-300-PM with a JEL standard vacuum type end-effector. Provide positive pressure depending on the wafer holding method such as edge grip or Bernoulli.

- Robot' s main body weight: Approximately 20 kg
- Dimensions of C4000 controller: 300 (W) x 110 (D) x 120 (H), Weight: Approximately 2 kg Note: A CE/KCs compliant controller has different dimensions and weight.

## SCR3000 series

#### A wide range of variations to meet system layouts

SCR3 30 - PM 60CS 0 0 0 0 0 5 0 0 6 0 0 \*Optional variation

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## STCR4160S-300-PM

## 4-Axis Cylindrical Coordinate Type Twin-Arm Clean Robot

## Clean Robot STCR4000S series

Featuring an open-loop control system and stepping motors, this series ensures high safety and stability. This JEL's long-term standard robot allows users to customize easily. Suitable for various types of wafers up to 300 mm.





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Controller: C4000 Control method: RS232C and parallel photo I/O



Teaching box: JCT1



## Characteristics

- Twin-arm reduces tact time to replace wafers.
- ◆ Base or flange mounting type is selectable according to system layouts.
- ◆ Optimal end-effector is selectable according to the carrying object and line layout.
- Payload capacity: 3 kg or less (calculated on the arm 3rd joint)
- Compatible with the former STHR model and current STCR4000SN series. this STCR4000S series ensures easier replacement.

## Specifications

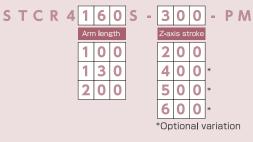
Carrying object	Wafers up to 300 mm				
	Arm Rotation angle		Vertical stroke		
Operating range* (3rd joint center)	315 mm	315 mm 340 degrees			
Speed (Avg)*	570 mm/sec 220 degree/sec 200 mm/sec				
Speed (Max)*	1140 mm/sec	140 mm/sec 270 degree/sec			
Resolution*	12.6 μm or less 0.0045 degrees		6,25 μm		
Handling level*	620 mm (Base mounting level to the end-effector level)				
Repeatability	Within +/- 0,1 mm				
Cleanliness	ISO Class 2 (when exhausted from the driving area)				
Utility*	Power: 24 V DC +/-	Power: 24 V DC +/- 10%, 16 A; Vacuum: -53 kPa or more			

\*Specifications of STCR4160S-300-PM with JEL standard vacuum type twin end-effectors. Provide positive pressure depending on the wafer holding method such as edge grip or Bernoulli.

 Robot's main body weight: Approximately 30 kg
 Dimensions of C4000 controller: 300 (W) x 110 (D) x 120 (H), Weight: Approximately 2 kg Note: A CE/KCs compliant controller has different dimensions and weight.

## STCR4000 series

#### A wide range of variations to meet system layouts



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# GCR4210-300-PM

## 4-Axis Horizontal and Multi-Joint Type Single-Arm Clean Robot

## Clean Robot GCR4000-PM Series

Featuring stepping motors with absolute encoders, this series ensures high safety and stability. This JEL's long-term standard robot allows users to customize easily. Suitable for various types of wafers up to 300 mm.





Usage environment and specifications

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### Characteristics

- 2 FOUP access without a track
- ♦ Base or flange mounting type is selectable according to system layouts.
- Payload capacity: 3 kg or less (calculated on the arm 3rd joint)

### Specifications

Carrying object	Wafers up to 300 mm				
	Arm	Rotation angle	Vertical stroke		
Operating range* (3rd joint center)	400 mm	335 degrees	300 mm		
Speed (Avg)*	730 mm/sec 280 degree/sec 200 mm/sec				
Speed (Max)*	1100 mm/sec	400 degree/sec	250 mm/sec		
Resolution*	0.0055 degrees 0.0025 degrees		6,25 μm		
Handling level*	620 mm (Base mounting level to the end-effector level)				
Repeatability	Within +/- 0,1 mm				
Cleanliness	ISO Class 2 (when exhausted from the driving area)				
Utility*	Power: 24 V DC +/- 10%, 15 A; Vacuum: -53 kPa or more				

\*Specifications of GCR4210-300-PM with a JEL standard vacuum type end-effector. Provide positive pressure depending on the wafer holding method such as edge grip or Bernoulli.

- This series comes in two types of motors: stepping motors or AC servo motors.
- Robot' s main body weight: Approximately 28 kg
- Dimensions of C4451 controller: 300 (W) x 230 (D) x 142 (H), Weight: Approximately 2 kg Note: A CE/KCs compliant controller has different dimensions and weight.

## GCR-PM series

#### A wide range of variations to meet system layouts



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Please contact our sales representatives for details of this product.

Teaching box: JCT5B

Controller: C4451

 Control method: RS232C and parallel photo I/O

# GTCR5280-300-AM

5-Axis Horizontal and Multi-Joint Type Single-Arm Twin End-Effector Clean Robot

## Clean Robot GTCR5000 Series

Twin end-effectors mounted on its single-arm, this series has the same function as a twin-arm robot. AC servo motors capable of high-speed handling ensures high safety and stability. Suitable for various types of wafers or substrates as well as wafers up to 300 mm.



Usage environment and specifications



#### Option (C) \$ ce \*CE marking is available CE Thin Wafer KCs upon request. Transfer method



## Characteristics

- Capable of transferring large diameter wafers and small FPD glass substrates.
- High-speed 3 FOUP access without a track for 300 mm wafers.
- AC servo motors with absolute encoders are installed in all axes.
- ◆ High-speed and high-accuracy wafer handling by optimizing pass control.
- Payload capacity: 4 kg or less (calculated on the arm 3rd joint)

## **Specifications**

Carrying object	Wafers up to 300 mm			
	Arm Rotation angle		Vertical stroke	
Operating range* (3rd joint center)	553 mm	335 degrees	300 mm	
Speed (Avg)*	833 mm/sec 250 degree/sec 300 mm/se			
Speed (Max)*	1400 mm/sec	350 degree/sec	450 mm/sec	
Resolution*	0.0011 degrees	0.0013 degrees	1.96 µm	
Handling level*	698 mm (Base mounting level to the end-effector level)			
Repeatability	Within +/- 0.1 mm			
Cleanliness	ISO Class 2 (when exhausted from the driving area)			
Utility*	Power: Single phase 200 V AC +/- 10%, 20 A; Vacuum: -53 kPa or more			

\*Specifications of GTCR5280-300-AM with JEL standard vacuum type twin end-effectors. Provide positive pressure depending on the wafer or substrate holding method such as edge grip or Bernoulli.

- Robot's main body weight: Approximately 53 kg
- Dimensions of C5000S controller: 370 (W) x 330 (D) x 270 (H), Weight: Approximately 15 kg Note: A CE/KCs compliant controller has different dimensions and weight.

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A wide range of variations to meet system layouts

Controller: C5000S Control method: RS232C and parallel photo I/O



Teaching box: JCT5B



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\*Optional variation

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- AM



## SVCR3260-020-PM

## 3-Axis Cylindrical Coordinate Type Single-Arm Clean Robot

## Vacuum Clean Robot SVCR3000 Series

Suitable for various types of wafers up to 300 mm in a vacuum environment. Featuring an open-loop control system and stepping motors, this series ensures high safety and stability. This JEL's long-term standard robot allows users to customize easily.



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\*CE or KCs marking is

available upon request.

### Suitable for vacuum environment

Characteristics

- Magnetic fluid sealing is used in each arm joint.
- Vacuum sealing: Magnetic fluid sealing and a bellows are used.
- ◆ Cleanliness: A mesh filter is installed for the internal exhaust of the arm.
- Payload capacity: 2 kg or less (calculated on the arm 3rd joint)
- ◆ Compatible with the former SVHR model, this series ensures easier replacement.

## Specifications

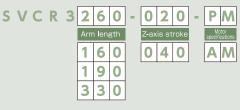
Carrying object	Wafers up to 300 mm				
	Arm	Rotation angle	Vertical stroke		
Operating range* (3rd joint center)	520 mm 330 degrees		20 mm		
Speed (Avg)*	300 mm/sec 120 degree/sec 20 mm/sec				
Speed (Max)*	550 mm/sec 170 degree/sec 30 mm/sec				
Resolution*	82 μm or less 0.009 degrees		1,25 μm		
Handling level*	98 mm (Flange mounting level to the end-effector level)				
Repeatability	Within +/- 0.1 mm				
Cleanliness	Magnetic fluid sealing and a filter				
Vacuum resistance	1.33 x 10-6 Pa				
Utility*	Power: 24 V DC +/- 10%, 8 A				

\* Representative specifications of SVCR3260-020-PM (stepping motor type)

- This series comes in two types of motors: stepping motors or AC servo motors.
- Robot's main body weight: Approximately 25 kg
- Dimensions of C4000 controller: 300 (W) x 110 (D) x 120 (H), Weight: Approximately 2 kg Note: A CE/KCs compliant controller has different dimensions and weight.

## SVCR3000 series

A wide range of variations to meet system layouts



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Controller: C4000 • Control method: RS232C and parallel photo I/O



Vacuum

Teaching box: JCT1





## STVCR4160S-050-PM

## 4-Axis Cylindrical Coordinate Type Twin-Arm Clean Robot

## Vacuum Clean Robot STVCR4000S Series

Suitable for various types of wafers up to 300 mm in a vacuum environment. Featuring an open-loop control system and stepping motors, this series ensures high safety and stability. This JEL's long-term standard robot allows users to customize easily.



Usage environment and specifications



Controller: C4000 Control method: RS232C and parallel photo I/O



Teaching box: JC4B



## Characteristics

- Suitable for vacuum environment
- Twin-arm reduces tact time to replace wafers.
- Magnetic fluid sealing is used in each arm joint.
- Vacuum sealing: Magnetic fluid sealing and a bellows are used.
- Cleanliness: A mesh filter is installed for the internal exhaust of each arm.
- Pavload capacity: 2 kg or less (calculated on the arm 3rd joint)
- Compatible with the former STVHR model, this series ensures easier replacement.

## **Specifications**

Carrying object	Wafers up to 300 mm				
	Arm	Rotation angle	Vertical stroke		
Operating range* (3rd joint center)	310 mm	330 degrees	50 mm		
Speed (Avg)*	300 mm/sec 110 degree/sec		30 mm/sec		
Speed (Max)*	550 mm/sec 150 degree/sec		50 mm/sec		
Resolution*	10.06 µm or less	0.00225 degrees	0.625 µm		
Handling level*	196 mm (Flange mounting level to the upper end-effector level)				
Repeatability	Within +/- 0.1 mm				
Cleanliness	Magnetic fluid sealing and filters				
Vacuum resistance	1.33 x 10 <sup>-6</sup> Pa				
Utility*	Power: 24 V DC +/-	- 10%, 16 A			

\* Representative specifications of STVCR4160S-050-PM (stepping motor type)

• This series comes in two types of motors: stepping motors or AC servo motors with absolute encoders.

Robot' s main body weight: Approximately 80 kg

• Dimensions of C4000 controller: 300 (W) x 110 (D) x 120 (H), Weight: Approximately 2 kg Note: A CE/KCs compliant controller has different dimensions and weight.

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## STVCR4000 series

A wide range of variations to meet system layouts



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# GTVCR5330-060-AM

5-Axis Horizontal and Multi-Joint Type Single-Arm Twin End-Effector Clean Robot

## Vacuum Clean Robot GTVCR5000 Series

Capable of transferring to parallel stages in vacuum chambers. Featuring AC servo motors that are capable of high-speed handling, this series ensures high safety and stability. Suitable for various types of wafers or substrates as well as wafers up to 300 mm in a vacuum environment.

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Thin Wafer

Transfer method





Controller: C5000S Control method: RS232C and parallel photo I/O



Teaching box: JCT5B



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KCs

\*CE marking is available

upon request.

Vacuum

CE

CE

## Suitable for vacuum environment

Characteristics

- Capable of transferring to parallel stages in vacuum chambers.
- Magnetic fluid sealing is used in each arm joint.
- ◆ Vacuum sealing: Magnetic fluid sealing and a bellows are used.
- Cleanliness: A mesh filter is installed for the internal exhaust of each arm.
- Payload capacity: 4 kg or less (calculated on the arm 3rd joint)

## **Specifications**

Carrying object	Wafers up to 300 mm					
	Arm	Rotation angle	Vertical stroke			
Operating range* (3rd joint center)	635 mm	360 degrees	60 mm			
Speed (Avg)*	640 mm/sec 160 degree/sec 60 mm/sec					
Speed (Max)*	950 mm/sec 200 degree/sec 85 mm/sec					
Resolution*	0.00081 degrees	degrees 0.00072 degrees 0.98 µm				
Handling level*	219 mm (Flange mounting level to the upper end-effector level)					
Repeatability	Within +/- 0.1 mm					
Cleanliness	Magnetic fluid sealing and a filter					
Vacuum resistance	1.33 x 10 <sup>-6</sup> Pa					
Utility*	Power: Single phase 200 to 230 V AC +10% to -15%, 2 kVA, 50/60 Hz					

\* Representative specifications of GTVCR5330-060-AM

- Robot's main body weight: Approximately 75 kg
  Dimensions of C5000S controller: 370 (W) x 330 (D) x 270 (H), Weight: Approximately 23 kg Note: A CE/KCs compliant controller has different dimensions and weight.

## **GTVCR5000** series

♦ A wide range of variations to meet system layouts



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## SAL38C4HV

## Aligner for Multiple Types of Wafers

## A prealigner for aligning multiple types of wafers—regardless of wafer materials such as mirror surface, transparent or translucent wafer; warped wafer; or non-standard notch or orientation flat.

Just one aligner handles ever-difficult positioning of wafers with irregular warpage or different light transmittance. (\*1)



## Characteristics

- Available for silicon wafers with BG tape as well as silicon, transparent, or translucent wafers.
- Available for non-SEMI standard notch or flat.
- Z-axis capable of redo operations is optional.
- ◆ Full auto-adjustment software JEL ALIGN TOOL comes with the aligner.
- Motor drivers and a controller are built in the aligner.

## Specifications

Carrying object	2 inch to 150 mm (SAL3264HV) 100 to 200 mm (SAL3484HV) 200 to 300 mm (SAL38C4HV)
Positioning time	Centering: 3 sec (*1)
Positioning accuracy	Centering: Within +/- 0.1 mm (*1) Orientation flat/notch locating: Within +/- 0.1 degrees (*1)
Sensor method	LED lighting with wafer edge detection using an image sensor unit
Wafer size switching	Switching by command control or by communication
Cleanliness	ISO Class 2 (when exhausted from the driving area)
Utility	Power: 24 V DC +/- 10%, 3 A; Vacuum: -53 kPa or more

#### • Aligner's main body weight: Approximately 10 kg

(\*1): The accuracies of wafer detection, positioning time or positioning may vary depending on the wafer. An operation test using the target sample wafers is performed before delivery.

## SAL3000HV series

A wide range of variations to meet your wafer size

SAL38C4HVZ\* Vafer size 26 48

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## KHR3480-290-AM Atmosphere

## Linear arm type clean robot (for 25 wafers batch transfer, 300 mm wafers)

Capable of transferring 25 wafers at once.

The transfer time can be significantly reduced by batch transfer. Available for the layout with multiple cassettes by equipping a rotation axis.

### Characteristics

- RS232C are standard for control.
- End-effector material: ceramic
- ♦ Wafer holding: end-effector with passive edge, edge alignment.
- AC servo motors with absolute encoders installed in all axes (Batteryless)

## MTCR4160-300-AM Atmosphere

4-Axis Cylindrical Coordinate Type Twin-Arm Clean Robot

### Clean Robot MTCR4000 Series

High-speed handling by AC servo motors for all axes. Suitable for high throughput.

#### Characteristics

- ◆ Arm length: 160 mm, 200 mm, 280 mm
- ♦ Vertical stroke: 300 mm, 400 mm, 420 mm, 500 mm
- Payload capacity: 4 kg or less (calculated on the arm 3rd joint)
- Twin-arm reduces tact time to replace wafers.
- Base or flange mounting type is selectable according to system layouts.
  AC correction with absolute apponents are installed in all averages.
- AC servo motors with absolute encoders are installed in all axes.
- Wafer holding: end-effector with vacuum suction, passive edge, edge grip, or Bernoulli type



## GCR4280-300-AM Atmosphere

4-Axis Horizontal and Multi-Joint Type Single-Arm Clean Robot

### Clean Robot GCR4280-AM Series

#### Characteristics

- Arm length: 280 mm
- ♦ 3 FOUP access for 300 mm wafers without a track
- Vertical stroke: 300 mm, 420 mm
- Payload capacity: 4 kg or less (calculated on the arm 3rd joint)
- Base or flange mounting type is selectable according to system layouts.
- AC servo motors with absolute encoders are installed in all axes.
  Wafer holding: end-effector with vacuum suction, passive edge, or edge grip

## MCR3160C-300-AM Atmosphere

## 3-Axis Cylindrical Coordinate Type Single-Arm Clean Robot

### Clean Robot MCR3000C Series

High-speed handling by AC servo motors for all axes. Suitable for high throughput.

#### Characteristics

- Arm length: 160 mm, 200 mm, 280 mm
- Vertical stroke: 300 mm, 400 mm, 420 mm, 500 mm
- Payload capacity: 4 kg or less (calculated on the arm 3rd joint)
- Base or flange mounting type is selectable according to system layouts.
- AC servo motors with absolute encoders are installed in all axes.
- Wafer holding: end-effector with vacuum suction, passive edge, edge grip, or Bernoulli type

## SVCR3330-060-AM Vacuum

3-Axis Cylindrical Coordinate Type Single-Arm Clean Robot

### Vacuum Clean Robot SVCR3000 Series

Designed for handing of heavy weight carrying objects such as susceptors or trays in vacuum chambers.

### Characteristics

- Arm length: 330 mm
- Vertical stroke: 60 mm
- Payload capacity: 10 kg or less (calculated on the arm 3rd joint)
  Magnetic fluid sealing is used in each arm joint.
- Vacuum sealing: Magnetic fluid sealing and a bellows are used.
- Cleanliness: A mesh filter is installed for the internal exhaust of the arm
- AC servo motors with absolute encoders are installed in all axes.
- ♦ Wafer holding: end-effector with passive edge







## SWCR3160CS-300-PM Waterproof

### 3-Axis Cylindrical Coordinate Type Single-Arm Clean Robot

#### Waterproof Clean Robot SWCR3000 Series

Edge grip with the flip function for 300 mm wafers. Designed for handling wafers in LSI production lines under acid conditions or alkaline mist (IP64).

#### Characteristics

- Arm length: 160 mm
- Vertical stroke: 200 mm, 300 mm
- Payload capacity: 3 kg or less (calculated on the arm 3rd joint)
- Corrosion resistance teflon coatings protect the arm.
  V-type seals are used for waterproofing of the arm joint.
- FKM seals are used for parts joint.
- A bellows is used for waterproofing of the z-axis.
- A bellows is used for waterproofing of the 2-axis.
  2-phase stepping motors are installed in all axes.
- Wafer holding: end-effector with vacuum suction, passive edge, or edge grip

## SAL20C1 Atmosphere

## Edge Grip Type Aligner for 300 mm Wafers

## Edge grip type prealigner minimizes a wafer contact.

#### Characteristics

- High-speed and high-accuracy wafer centering and notch locating by the edge grip function.
- Designed to reduce contamination of friction surface.
- Suitable for 150 mm, 200 mm or other sizes of wafers.
- Motor drivers and a controller are built in the aligner.

## SVAL3001 Vacuum

### Vacuum Aligner

Edge grip type prealigner for positioning silicon wafers or susceptors in a vacuum environment.

#### Characteristics

- Payload capacity: 4 kg
- $\blacklozenge$  Stand-alone aligner using a vacuum resistance positioning sensor
- Vacuum sealing: Magnetic fluid sealing and a bellows are used.
- Rotation to any angle by index function which matches a layout of wafers in a tray





#### Designed for handling wafers in LSI production lines under acid conditions or alkaline mist (IP64).

#### Characteristics

- Vertical stroke: 200 mm, 300 mm
- Payload capacity: 3 kg or less (calculated on the arm 3rd joint)
- Corrosion resistance teflon coatings protect the arm.
- V-type seals are used for waterproofing of the arm joint.
- FKM seals are used for parts joint.
- A bellows is used for waterproofing of the z-axis.
- Twin-arm reduces tact time to replace wafers.
- 2-phase stepping motors are installed in all axes.
  Wafer holding: end-effector with vacuum suction, passive edge, or edge grip
- Transfer System Atmosphere

## Tabletop Loader System / Sorter System / Automatic Wafer Transfer System for Wafer Container

### A variety of systems from a tabletop to a large box shape to meet your needs

Sorter System

#### Tabletop Loader System



#### Automatic Wafer Transfer System for Wafer Container







End-Effector	Lineup

## Vacuum Suction Type End-Effector

#### I-shaped and Y-shaped vacuum suction type end-effectors

Used extensively for atmospheric robots, these vacuum suction type end-effectors hold the backside of a wafer by vacuum suction (negative pressure).

Conductive teflor coating on the surface of the end-effectors protect against damage from charging.

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Model	SC-IW-200	SC-IW-240	SC-YW-200	SC-YW-227	3D-02229	3D-01661
Carrying object	Mainly silicon wafe	ers				
Size	3 inch, 100 to 200 mm	3 inch, 100 to 200 mm	100 to 200 mm	100 to 200 mm	150 to 300 mm	300 mm
Total length	200 mm	240 mm	200 mm	227 mm	242 mm	242 mm
Thickness	2 mm	2 mm	2 mm	2 mm	2 mm	3 mm
Material	High purity alumina ceramic sintered body					
Surface treatment	Conductive teflon coating					
Surface treatment	Conductive tenon	00001118				

## **Bernoulli Hand**

A Bernoulli wand for 2 to 3 inch, 100 to 150 mm wafers

in semiconductor device production processes or in semiconductor wafer manufacturing factories, this wafer handling device is used to manually pick up/place thin wafers from/in wafer containers or cassettes.

Bernoulli Hand, a light and compact wand, holds thin wafers using the Bernoulli principle. Wafer breakage risk is minimized due to non-suction holding. With the flexible front edge, Bernoulli Hand picks up/places wafers from/in wafer containers or wafer cassettes. Accessible to various special substrates as well as wafers.

#### Characteristics

- Wafers are lifted by the Cyclone effect.
- Wafer holding by a pad (Fluorine-contained rubber)
   An operator can adjust Bernoulli
- Hand in various angles with a flexible tube.
- Note: Please contact our sales representatives for various shapes and sizes of other wafers or substrates.

-End-effector

Water

-End-effector

Swirling

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## **Edge Grip End-Effector**

An end-effector for handling the back side treated wafers, which contacts the edges only.

Centering of a wafer during operation is suitable for transferring to the drop-in type stage. An air cylinder moves a guide of the edge grip end-effector back and forth to hold a wafer.



### Passive Edge Holding Type End-Effector

Suitable for handling warped wafers or thin wafers that cannot be held properly with a standard vacuum suction type end-effector. An end-effector for handling wafers, which contacts the back side as well as the edges. A tapered guide is used to hold a wafer by the weight of a wafer (passive grip).



Low cost end-effectors for thin or warped wafers using the Bernoulli principle are suitable for any type of JEL atmospheric robots. Design solution and evaluation using sample wafers based on the customer's request about the wafer size, warpage or thickness.

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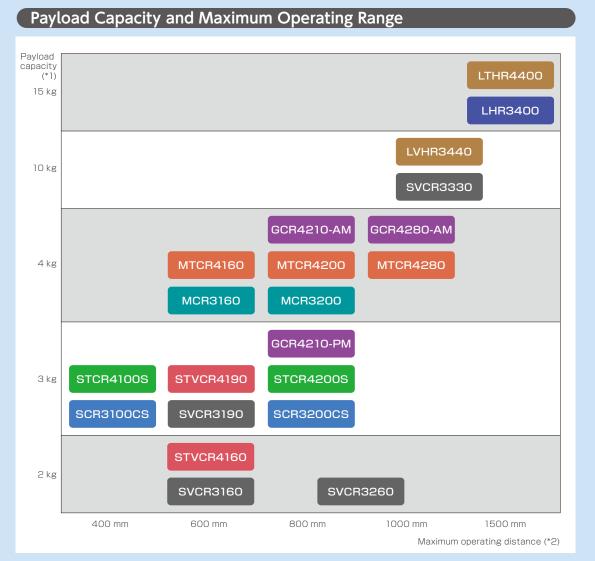


**Bernoulli End-Effector** 

Contact type and non-contact type Bernoulli end-effectors

	Material	Aluminum	Pad -
	Surface treatment	Black alumite	Guide
	Wafer holding method	By Bernoulli's principle using Cyclone pads and guides (PEEK) (Various materials are available for the contact area.)	
	Utility	30 to 80 L/min (Varies depending on the wafer size and thickness.)	(Holding both ends of wafer to avoid displa
)	Material	Aluminum	Pad
	Surface treatment	Black alumite	(
	Wafer holding method	By Bernoulli's principle using Cyclone pads and friction rubber (H-NBR) (Various materials are available for the contact area.)	Friction nutber
	Utility	30 to 80 L/min (Varies depending on the wafer size and thickness.)	Swirlin

## • How to Select JEL Robots

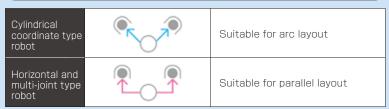


(\*1) Payload capacity values are the values calculated on the arm 3rd joint, and not the weight of carrying objects.
 (\*2) Maximum operating distance values are reference values including the end-effector and wrist-block.
 Note: Many products other than those listed are available. For more details, visit our website: www.jel-robot.com

## Product Series

	Single arm	Twin arm	Main use and transfer method
	SCR3000CS	STCR4000S	For semiconductors (Cylindrical)
	SCR3000CSN	STCR4000SN	For semiconductors (Cylindrical)
Atmospheric robot	MCR3000	MTCR4000	For semiconductors (Cylindrical)
TODOL	GCR4000	GTCR5000	For semiconductors (Horizontal and multi-joint)
	LHR3000	LTHR4000	For FPD glass substrates (Cylindrical)
Vacuum robot	SVCR3000	STVCR4000	For semiconductors (Cylindrical)
Waterproof robot	SWCR3000CS	STWCR4000S	For semiconductors (Cylindrical)

## Transfer Method



## **Robot Training**

JEL provides our customers with robot trainings for safe and effective operations.

- [Training place]
- JEL Head office
- JEL Tokyo branch
- Overseas service base



#### **Domestic production base Overseas Agents & Service Bases Domestic service base** JEL CORPORATION ■ JEL CORPORATION Korea Taiwan Beijing Saba Factory **Head Office** IELC P 245-1 Saba-cho, Fukuvama-citv. IEL I Hiroshima, 720-0835 Japan TEL: +81-84-952-5590 向沿部 Location map JELK CO., LTD. Challentech **Beijing REJE JEL Kochi** Automation Co., Ltd. https://www.jelk.co.kr International 75, Seokmun-gil, Seonggeo-eup, Corporation https://www.reje.com.cn Techno Park 4. Tosavamada-cho. Seobuk-gu, Cheonan-si, Chungnam-do 31053, Korea https://www.challentech.com.tw Kami-city, Kochi, Building 3, No.10, Kechuang 10th Street, 782-0010 JAPAN No.21. Taihe Rd., Zhubei Citv. BDA, Beijing 101111, China TEL: +82-41-583-6360 Hsinchu County 30267, Taiwan (R.O.C.) TEL: +86-10-5382-2087, TEL: +81-887-53-1181 FAX: +82-41-583-6469 +86-133-2115-2839 E-mail: kochi@jel-robot.co.jp E-mail: master@jelk.co.kr TEL: +886-3-5536525 E-mail: xiaoshou06@reje.com.cn FAX: +886-3-5531908 E-mail: I obo@challentech.com.tw Location map **Overseas Agents Overseas sales base** Korea Shangha Taiwan JEL CORPORATION Inatech&CORP R 2-8-20, Kusado-cho, Fukuyama-city, JEL (Shanghai) Robotics Co., Ltd. Hiroshima, 720-0831 JAPAN 625 6F, CHAMTIME Tower C, No.3, TEL: +81-84-932-6500 Lane 2889 Jinke Road, Pudong 间消除的 E-mail: info@jel-robot.co.jp Shanghai REJE Inatech & CORP Inc. JEL Automation Co., Ltd. New District, Shanghai P.R., China Location map http://www.inatechncorp.com Robotics Co., Ltd. TEL: +86-21-2050-1625(Landline) https://www.jel-automation.com +86-13021105268(Mobile) https://www.reje.com.cn #C-812, 168, Gasan digital 1F., No. 29, Jiazheng 9th St., Tokyo Branch E-mail: shanghai@jel-robot.com Zhubei City, Hsinchu County 302053 Taiwan (R.O.C.) 1-ro. Geumcheon-au. 6F. CHAMTIME Tower C. No.3. Lane 2889 Seoul 08507, Korea JinkeRoad, Pudong New District, Shanghai 200120, P.R. China TEL: +82-2-2026-0660 TEL: +886-3-6583741 FAX: +82-2-2026-0661 E-mail: alex.chen@jel-automation.com Kanda Bundo Building TEL: +86-21-2050-1619, +86-178-1202-2295 Korea Branch E-mail: jel-robot@inacorp.co.kr E-mail: xiaoshou05@reie.com.cn 2F. 4-18. F20Ho, 4F 401,402Ho, 526, U.S.A (CA) Germany USA Kandasakuma-cho, Maesonggosaek-ro, Gwonseon-gu, Chivoda-ku, Tokyo, Suwon-si, Gyeonggi-do 16634, Korea motomation motomation 101-0025 JAPAN TEL: Korea) +82-10-3481-6360 Japan) +81-80-6340-9905 TEL: +81-3-5825-9071 (080-6340-9905) E-mail: ikl@iel-robot.co.ip E-mail: tokyjim@jel-robot.co.jp JEL (Changzhou) Robotics Hine Automation, LLC **AES** motomation Inc. **AES motomation GmbH** Technology Co., Ltd. https://hineautomation.com http://www.motomation.com http://www.motomation.com 12495 34th St. North, Suite B 4041 Clipper Court Fremont, Duesselstrasse 8a D-41564 Kaarst Building 5, Changzhou Oriental St. Petersburg, FL 33716, U.S.A. CA 94538, U.S.A. Germany Automotive Electronics Industrial TEL: +1-813-749-7519 TEL: +1-510-490-9400 TEL: +49-0-2131-7768-10 Park, No. 1668, Dongguan Road, E-mail: info@motomation.con E-mail: info@motomation.com Lucheng Street, Wujin District, Changzhou City, Jiangsu Province **/** Overseas Partners 213025. China 回降 TEL: +86-13021105268(Mobile) Location map Shandhai DISTRIBUTOR Company Name : JEL Corporation Type of business: Manufacture and sales of electronic equipment SINTAIKC Capital : 74,570,000 (JPY) Major products : Wafer transfer robots and wafer handling systems for semiconductor equipment profile Contact NAGASE's office in China • Founded : 1993 FPD glass substrate transfer robots and FPD glass handling systems : The Bank of MUFG Bank, Ltd. President: Nobuo Sakiva Main banks Contact our sales representative for product request or questions. ducts videos are provided Sintaike Semiconductor Equipment (Shanghai) Co., Ltd. JEL CORPORATION You can also check http://www.sintaike.com

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JEL CORPORATION

ISO 9001

Head office.

Factory

ISO 1400

Head office

JQA-QM6952 JQA-EM6019

Building 6, Nanfang Urban Park, Lane 1165, Jindu

Road, Minhang District, Shanghai 201108, China.

TEL: +86-021-6088-8500

E-mail: info@sintaike.com

+86-135-6466-5802